

C0805C271JDGACTU

Aliases (C0805C271JDGAC7800) SMD Comm COG HV, Ceramic, 270 pF, 5%, 1,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	1.25mm +/-0.15mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

2500

Packaging Quantity

W 1.25mm +/-0.2mm To	olerance /oltage DC	5% 1000 \
	oltage DC	1000 \
T 1.25mm +/-0.15mm Vo		.000
S 0.7mm MIN Die	Pielectric Withstanding Voltage	1,200
B 0.5mm +/-0.25mm Te	emperature Range	-55/+
Те	emp. Coefficient	COG
Packaging Specifications Ca	Capacitance Change with	30 pp
Fackading TAR TOUTHIN Flashe Table	Reference to +25°C and 0 VDC Applied (TCC)	

Specifications	
Capacitance	270 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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